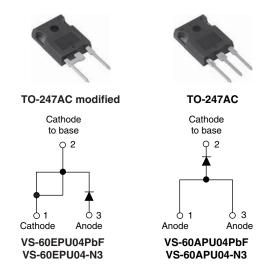
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Ultrafast Soft Recovery Diode, 60 A FRED Pt®



PRODUCT SUMMARY									
Package	TO-247AC, TO-247AC modified (2 pins)								
I _{F(AV)}	60 A								
V _R	400 V								
V _F at I _F	1.25 V								
t _{rr} typ.	See Recovery table								
T _J max.	175 °C								
Diode variation	Single die								

FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)

BENEFITS

- Reduced RFI and EMI
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION/APPLICATIONS

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Cathode to anode voltage	V _R		400	V						
Continuous forward current	I _{F(AV)}	T _C = 127 °C	60							
Single pulse forward current	I _{FSM}	T _C = 25 °C	600	А						
Maximum repetitive forward current	I _{FRM}	Square wave, 20 kHz	120							
Operating junction and storage temperatures	T _J , T _{Stg}		- 55 to 175	°C						

ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	400	-	-					
Forward voltage		I _F = 60 A		1.05	1.25	v				
	V _F	I _F = 60 A, T _J = 175 °C	-	0.87	1.03					
		I _F = 60 A, T _J = 125 °C	-	0.93	1.10					
		$V_{R} = V_{R}$ rated	-	-	50	μA				
Reverse leakage current	I _R	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	2	mA				
Junction capacitance	CT	V _R = 400 V	-	50	-	pF				
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	3.5	-	nH				

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DYNAMIC RECOVERY CHARACTERISTICS ($T_C = 25$ °C unless otherwise specified)											
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS					
Reverse recovery time		$I_F = 1 \text{ A}, dI_F/dt = 20$	-	50	60						
	t _{rr}	T _J = 25 °C		-	85	-	ns				
		T _J = 125 °C		-	145	-					
Dook roopyony ourrent	I _{RRM}	T _J = 25 °C	l _F = 60 A dl _F /dt = 200 A/µs	-	8.8	-	А				
Peak recovery current		T _J = 125 °C	$V_{\rm R} = 200 \text{ V}$	-	15.4	-	A				
Deverse verse vers	Q _{rr}	T _J = 25 °C		-	375	-	nC				
Reverse recovery charge		T _J = 125 °C		-	1120	-	nc				

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Thermal resistance, junction to case	R _{thJC}		-	-	0.70	K/W				
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.2	-	r\/ VV				
			-	5.5	-	g				
Weight			-	0.2	-	oz.				
Mounting torque			1.2 (10)	-	2.4 (20)	N · m (lbf · in)				
		Case style TO-247AC modified	60EPU04							
Marking device		Case style TO-247AC 60APU04								

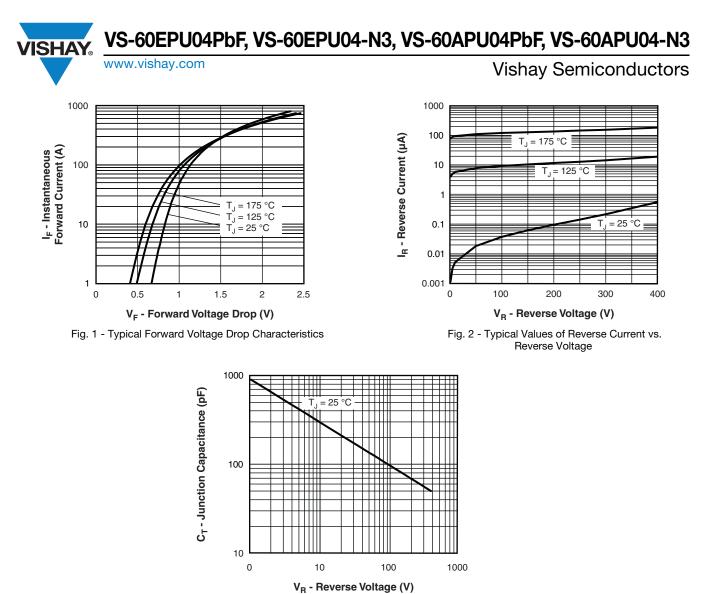


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

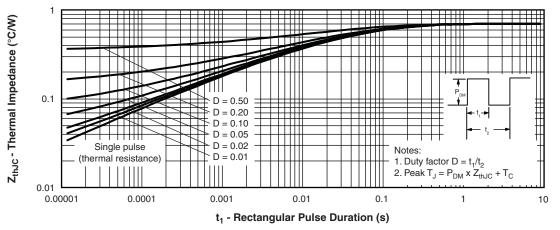


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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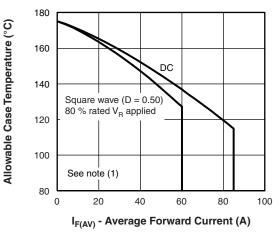


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

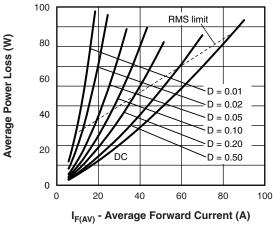
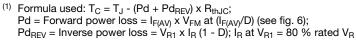


Fig. 6 - Forward Power Loss Characteristics

Note



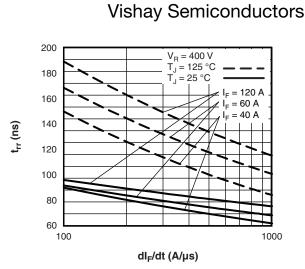


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

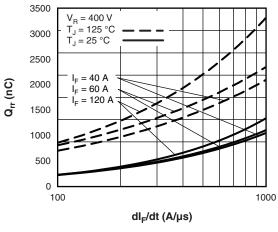


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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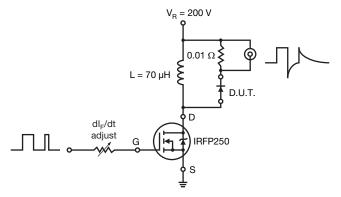
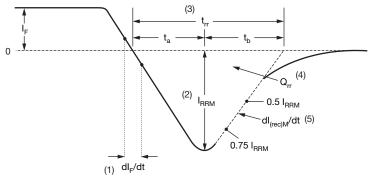


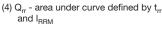
Fig. 9 - Reverse Recovery Parameter Test Circuit



(1) dl_F/dt - rate of change of current through zero crossing

(2) I_{RRM} - peak reverse recovery current

(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.



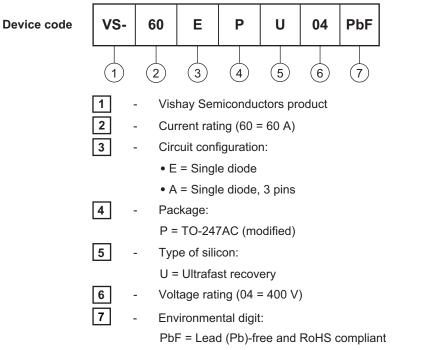
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

- (5) dI_{(rec)M}/dt peak rate of change of current during $t_{\rm b}$ portion of $t_{\rm rr}$
- Fig. 10 Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE



-N3 = Halogen-free, RoHS compliant and totally lead (Pb)-free

ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-60EPU04PbF	25	500	Antistatic plastic tube							
VS-60EPU04-N3	25	500	Antistatic plastic tube							
VS-60APU04PbF	25	500	Antistatic plastic tube							
VS-60APU04-N3	25	500	Antistatic plastic tube							

LINKS TO RELATED DOCUMENTS								
Dimensions	TO-247AC modified	www.vishay.com/doc?95253						
	TO-247AC	www.vishay.com/doc?95223						
	TO-247AC modified PbF	www.vishay.com/doc?95255						
Part marking information	TO-247AC modified -N3	www.vishay.com/doc?95442						
Part marking information	TO-247ACPbF	www.vishay.com/doc?95226						
	TO-247AC-N3	www.vishay.com/doc?95007						

Outline Dimensions





DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES				MILLIN	IETERS	INC	HES	NOTES	
STNIBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209			D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098			E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			FK	2.	54	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.37	0.065	0.094			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ΦP	3.56	3.66	0.14	0.144	
с	0.38	0.86	0.015	0.034			Φ P1	-	6.98	-	0.275	
c1	0.38	0.76	0.015	0.030			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3]	R	4.52	5.49	1.78	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

(6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c

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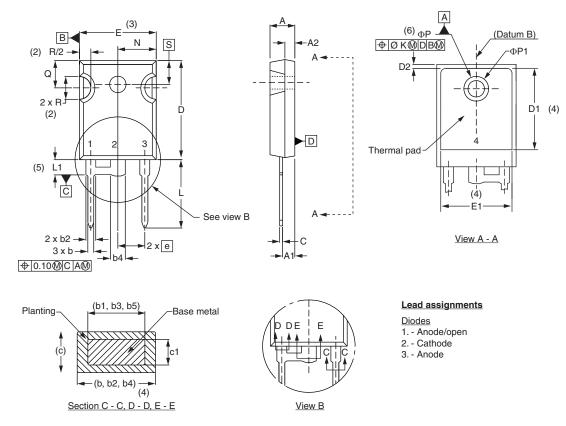
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Outline Dimensions





DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	STINDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209		D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102		E	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098		E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055		е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053		ΦK	2.	54	0.0)10	
b2	1.65	2.39	0.065	0.094		L	14.20	16.10	0.559	0.634	
b3	1.65	2.37	0.065	0.094		L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135		N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133		ΦР	3.56	3.66	0.14	0.144	
С	0.38	0.86	0.015	0.034		Φ P1	-	6.98	-	0.275	
c1	0.38	0.76	0.015	0.030		Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3	R	4.52	5.49	1.78	0.216	
D1	13.08	-	0.515	-	4	S	5.51	BSC	0.217	BSC	

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Revision: 21-Jun-11

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Document Number: 95253

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